

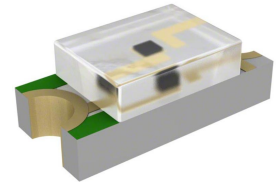
# SMD INFRARED LED

## KEL-0T026C

**SIVAGO**<sup>®</sup>  
SEMICONDUCTOR

### Features

- Small double-end package
- High reliability
- Low forward voltage
- Good spectral matching to Si photodetector
- Pb free
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH



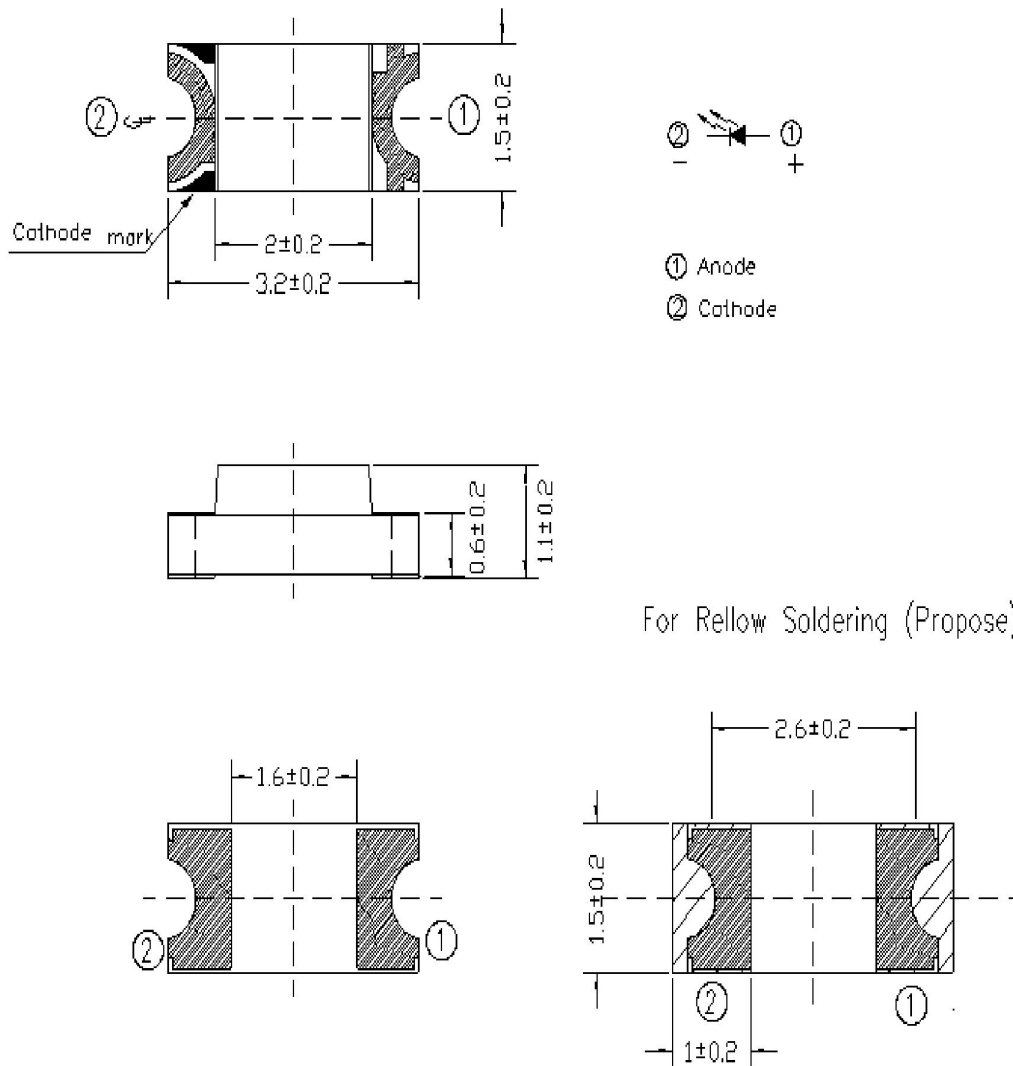
### Application

- PCB mounted infrared sensor
- Infrared emitting for miniature light barrier
- Floppy disk drive
- Optoelectronic switch
- Smoke detector

### Description

KEL-0T026C is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic With flat top view lens. The device is spectrally matched with silicon photodiode and phototransistor.

## PACKAGE DIMENSIONS



### NOTES:

- 1.All dimensions are in millimeters
- 2.Tolerances unless dimensions  $\pm 0.1\text{mm}$
- 3.Suggested pad dimension is just for reference only  
Please modify the pad dimension based on individual need

**ABSOLUTE MAXIMUM RATINGS AT TA =25°C**

<b>Parameter</b>	<b>Symbol</b>	<b>Rating</b>	<b>Units</b>
Continuous Forward Current	I <sub>F</sub>	65	mA
Reverse Voltage	V <sub>R</sub>	5	V
Operating Temperature	T <sub>opr</sub>	-25~ +85	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +85	°C
Soldering Temperature *1	T <sub>sol</sub>	260	°C
Power Dissipation at(or below) 25°C Free Air Temperature	P <sub>d</sub>	130	mW

**Notes:** \*1 Soldering time ≤ 5 seconds.

**ELECTRICAL OPTICAL CHARACTERISTICS AT TA=25°C**

<b>Parameter</b>	<b>Symbol</b>	<b>Condition</b>	<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	<b>Units</b>
Radiant Intensity	$I_e$	$I_F=20\text{mA}$	0.2	0.8	--	mW/sr
Peak Wavelength	$\lambda_p$	$I_F=20\text{mA}$	--	940	--	nm
Spectral Bandwidth	$\Delta\lambda$	$I_F=20\text{mA}$	--	45	--	nm
Forward Voltage	$V_F$	$I_F=20\text{mA}$	--	1.2	1.5	V
Reverse Current	$I_R$	$V_R=5\text{V}$	--	--	10	$\mu\text{A}$
View Angle	$2\theta_{1/2}$	$I_F=20\text{mA}$	--	160	--	deg

## Typical Electro-Optical Characteristics Curves

Fig.1 Forward Current vs. Ambient Temperature

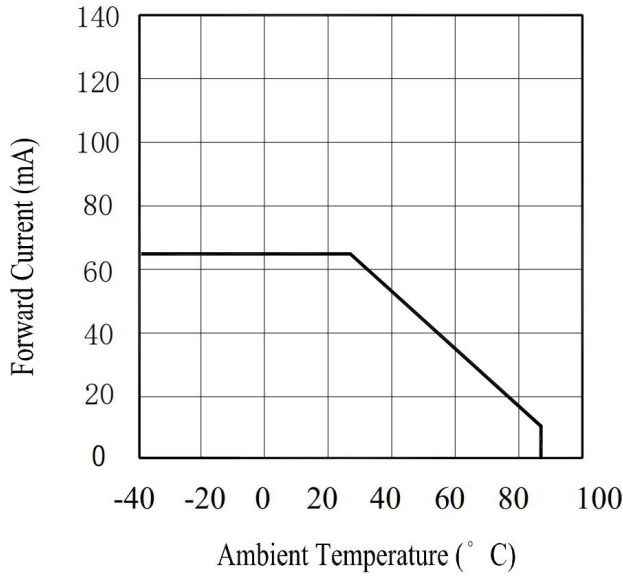


Fig.2 Spectral Distribution

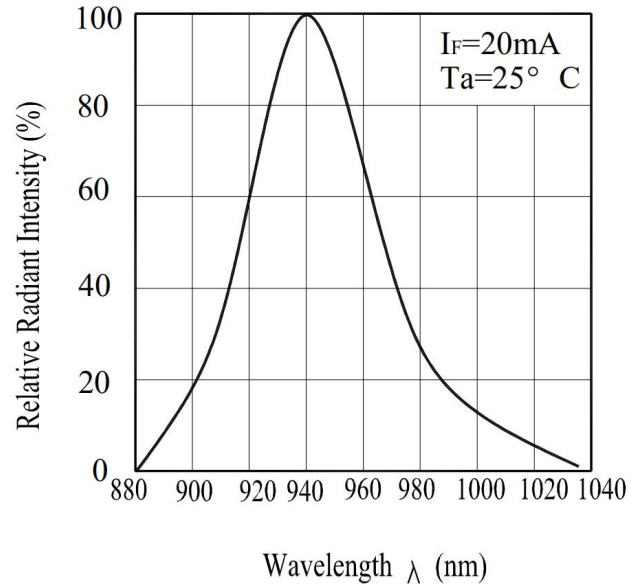


Fig.3 Forward Current vs. Forward Voltage

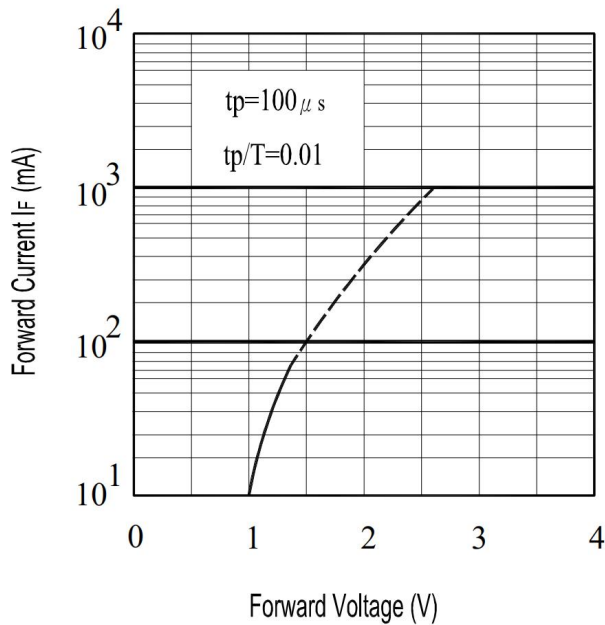
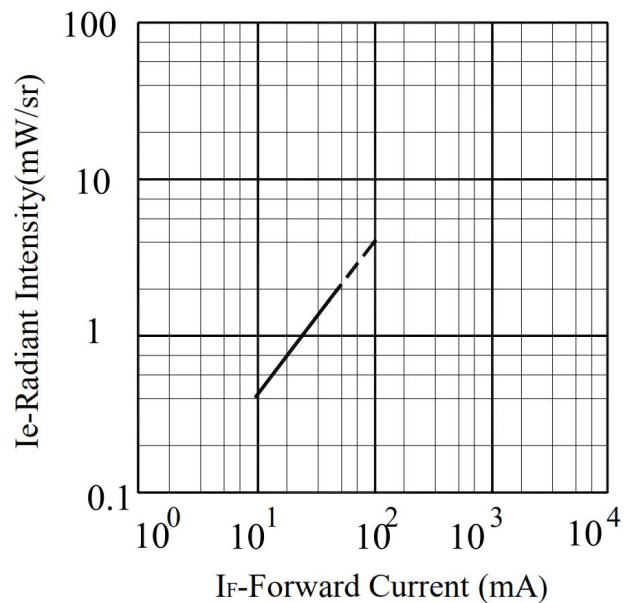
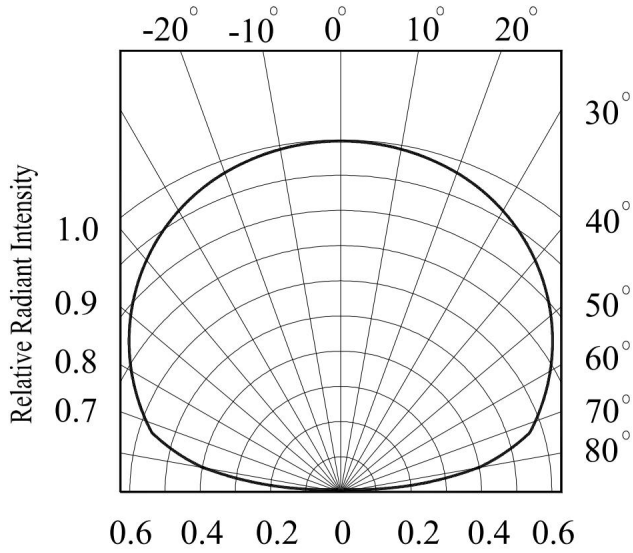


Fig.4 Relative Intensity vs. Forward Current



## Typical Electro-Optical Characteristics Curves

Fig.5 Relative Radiant Intensity vs.  
Angular Displacement



## Precautions For Use

### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

### 2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 10°C~30°C and 90%RH or less.

2.3 The LEDs suggested be used within one year.

2.4 After opening the package, the devices must be stored at 10°C~30°C and  $\leq 60\%RH$ , and used within 168 hours (floor life). If unused LEDs remain, it should be stored in moisture proof packages.

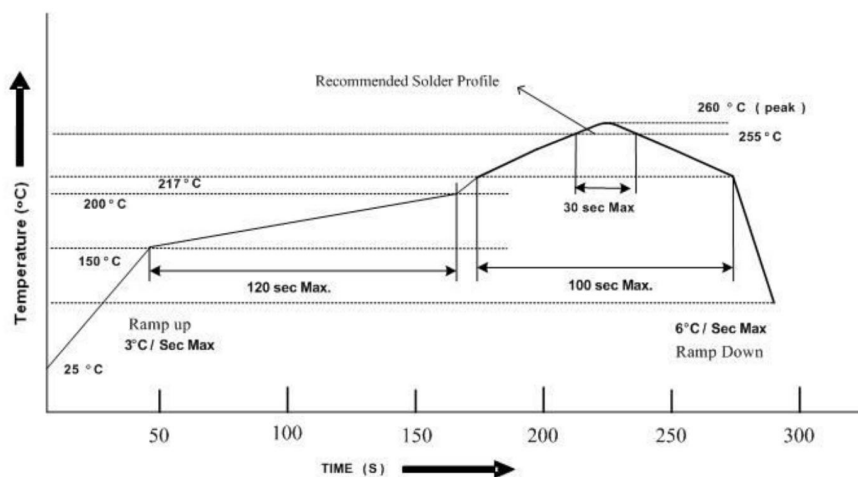
2.5 If the moisture absorbent material (desiccant material) has faded or unopened bag has exceeded the shelf life or devices (out of bag) have exceeded the floor life, baking treatment is required.

2.6 If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the following conditions:

96 hours at 60°C  $\pm$  5°C and < 5 % RH (reeled/tubed/loose units)

### 3. Soldering Condition

#### 3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

3.4 After soldering, do not warp the circuit board.

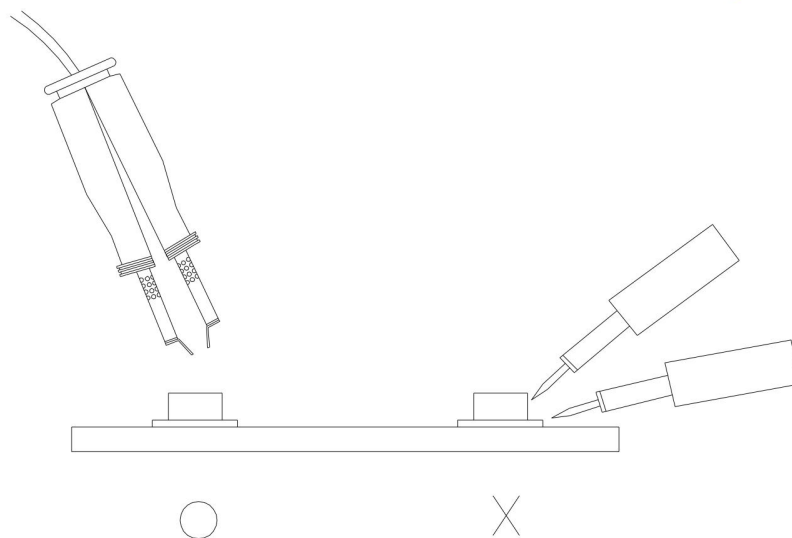


#### 4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

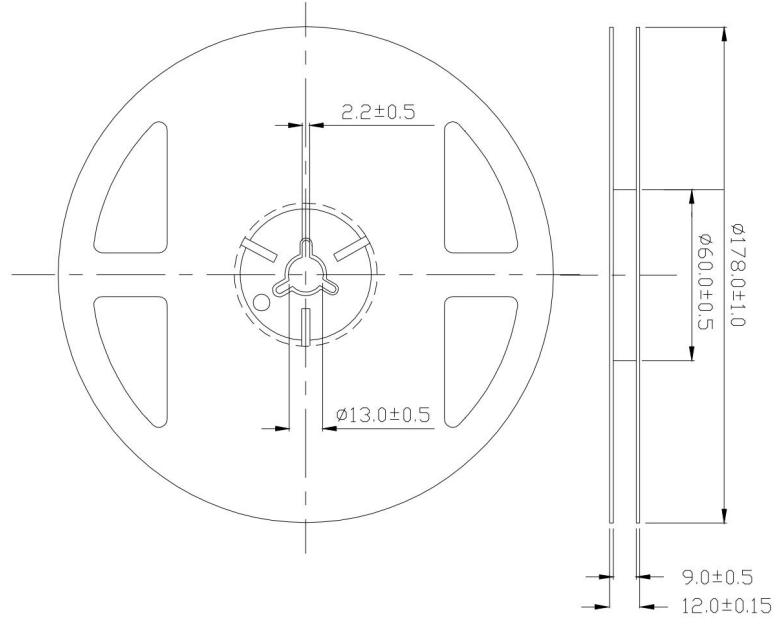
#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



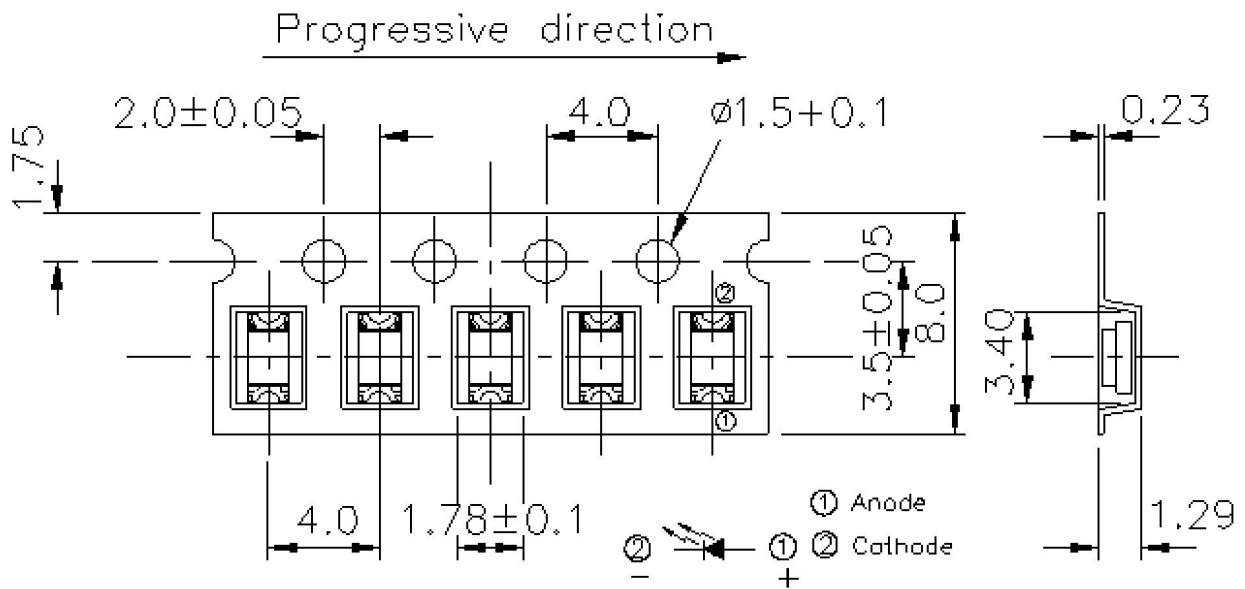


### Package Dimensions



**Note:** The tolerances unless mentioned are  $\pm 0.1$  mm, Unit: mm

### Carrier Taping Dimensions: (Quantity: 2000PCS/Reel)




**Note:** The tolerances unless mentioned are  $\pm 0.1$  mm, Unit: mm

## Packing Quantity Specification

1. 2000Pcs/1Reel,10 Bag/1Box
2. 4Boxes/1Carton

## Label Form Specification

製品名 PRODUCT	
コードNo. CODE No.	
数量 Q'TY	
ロットNo. LOT No.	
備考 REMARKS	
	

- PRODUCT: Part Number
- CODE NO.: Product Serial Number
- QTY: Packing Quantity
- LOT No: Lot Number
- REMARKS:Remarks

## Legal Disclaimer Notice

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